

60V N-Channel DTMOS

Features

- Trench Power DTMOS Technology
- Low R_{DS(ON)}
- Low Gate Charge
- Optimized for Fast-switching Applications

Applications

- Synchronous Rectification in DC/DC and AC/DC Converters
- Isolated DC/DC Converters in Telecom and Industrial

Product Summary

V_{DS} 60V

RDS(ON) (at VGS=10V) $< 9m\Omega$

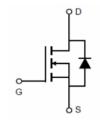
RDS(ON) (at VGS=4.5V) $< 13.5 \text{m}\Omega$

ID (at VGS=10V) 60A

100% UIS Tested







Device	Package	Marking
TSG12N06AT	DFN5×6	12N06AT

Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted				
Parameter		Symbol	Value	Unit
Drain-Source Voltage (V _{GS} =	= 0V)	V _{DSS}	60	V
Continuous Drain Current	$T_{\rm C} = 25^{\rm o}{\rm C}$	ı	60	- A
	$T_{\rm C} = 100^{\rm o}{\rm C}$	l I _D	36	
Pulsed Drain Current	(note1)	I _{DM}	240	Α
Gate-Source Voltage		V_{GSS}	±20	V
Single Pulse Avalanche Ene	rgy (note2)	E _{AS}	65	mJ
Avalanche Current	(note1)	I _{As}	36	А
Power Dissipation (T _C = 25°	C)	P _D	56.5	W
Operating Junction and Stor	age Temperature Range	T _J , T _{stg}	-55~+175	°C

Thermal Resistance					
Parameter	Symbol	Value	Unit		
Thermal Resistance, Junction-to-Case	R_{thJC}	1.7	°C/W		
Thermal Resistance, Junction-to-Ambient	R_{thJA}	50	30/00		



Specifications T _J = 25°C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Value		Max.	Unit		
Static			Min.	Тур.	IVIAX.			
		<u> </u>	T					
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 250\mu A$	60			V		
Zero Gate Voltage Drain Current	1	$V_{DS} = 60V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1			
Zero Gate Voltage Drain Gurrent	I _{DSS}	$V_{DS} = 60V, V_{GS} = 0V, T_{J} = 100^{\circ}C$			100	μΑ		
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20V$			±100	nA		
Gate-Source Threshold Voltage	$V_{\rm GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.1		2.5	V		
Drain Course On Registeres (Note2)	D	$V_{GS} = 10V, I_D = 20A$		6.5	9	mΩ		
Drain-Source On-Resistance (Note3)	R _{DS(on)}	$V_{GS} = 4.5V, I_{D} = 20A$		10.7	13.5			
Forward Transconductance (Note3)	g _{fs}	$V_{DS} = 5V, I_{D} = 20A$		85		S		
Dynamic								
Input Capacitance	C _{iss}	V 0V		2455		pF		
Output Capacitance	C _{oss}	$V_{GS} = 0V,$ $V_{DS} = 30V,$		240				
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		34				
Total Gate Charge	Q _g (10V)			45		nC		
	Q _g (4.5V)	$V_{DD} = 30V, I_{D} = 20A,$		24				
Gate-Source Charge	Q_{gs}	$V_{GS} = 10V$		6.8				
Gate-Drain Charge	Q_{gd}			11.5				
Turn-on Delay Time	t _{d(on)}			8				
Turn-on Rise Time	t _r	$V_{DD} = 30V, I_{D} = 20A,$		3		ns		
Turn-off Delay Time	t _{d(off)}	$R_G = 3\Omega$		25				
Turn-off Fall Time	t _f			4				
Drain-Source Body Diode Characteri	stics		•	•				
Continuous Body Diode Current	Is				46	А		
Pulsed Diode Forward Current	I _{SM}	$T_{C} = 25^{\circ}C$			138			
Body Diode Voltage	V_{SD}	$T_J = 25^{\circ}C$, $I_{SD} = 1A$, $V_{GS} = 0V$		0.72	1	V		
Reverse Recovery Time	t _{rr}	I _F = 20A,		25		ns		
Reverse Recovery Charge	Q _{rr}	$di_{F}/dt = 500A/\mu s$		110		nC		

Notes

- 1. Repetitive Rating: Pulse Width limited by maximum junction temperature
- 2. I_{AS} = 36A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 1%



Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

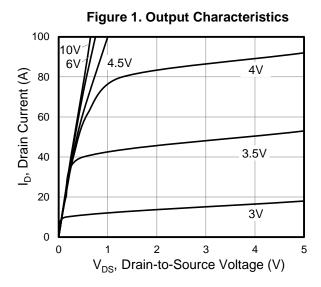


Figure 3. On-Resistance vs. Drain Current

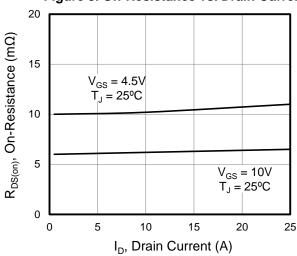


Figure 5. Gate Charge

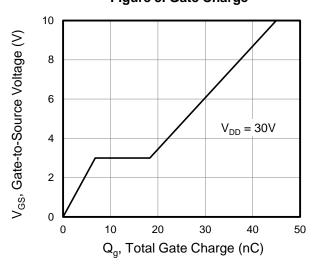


Figure 2. Transfer Characteristics $V_{DS} = 5V$

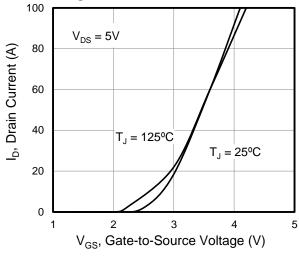


Figure 4. Capacitance

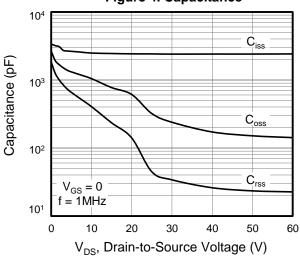
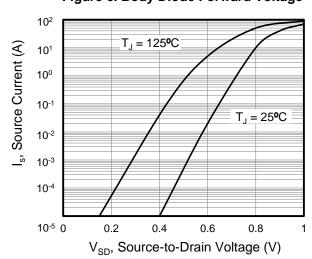


Figure 6. Body Diode Forward Voltage



Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

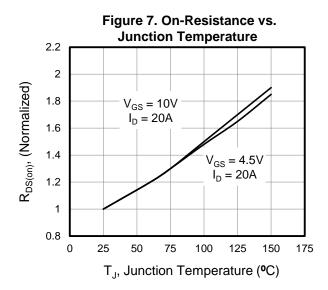


Figure 9. Transient Thermal Impedance

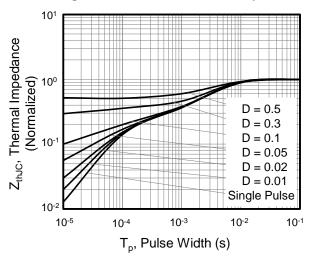


Figure 8. Threshold Voltage vs. Junction Temperature 1.2 1.1 V_{GS(th)}, (Variance) $I_{D} = 250 \mu A$ 0.9 8.0 0.7 0.6 0 -100 -50 50 100 150 200 T_J, Junction Temperature (°C)

Figure 10. Safe operation area

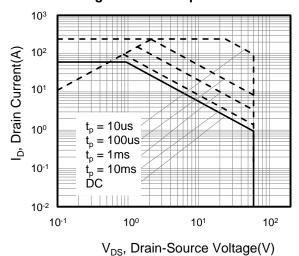




Figure A: Gate Charge Test Circuit and Waveform

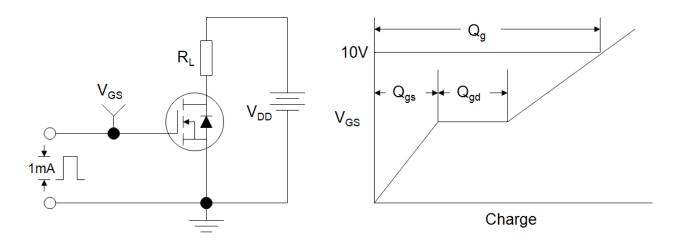


Figure B: Resistive Switching Test Circuit and Waveform

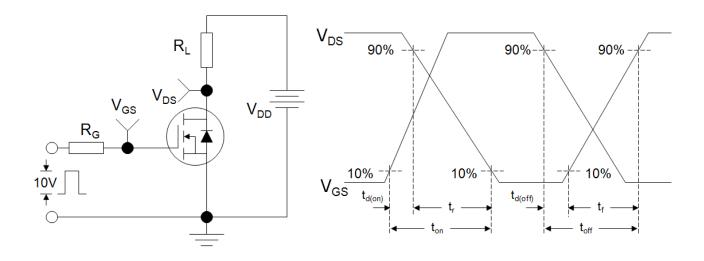
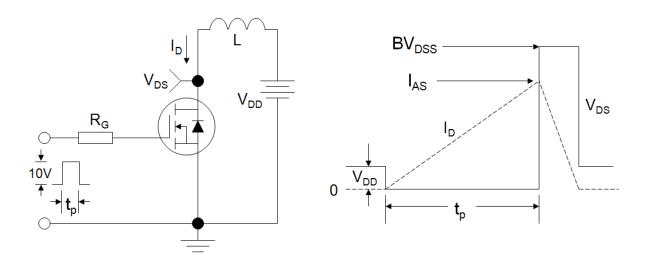
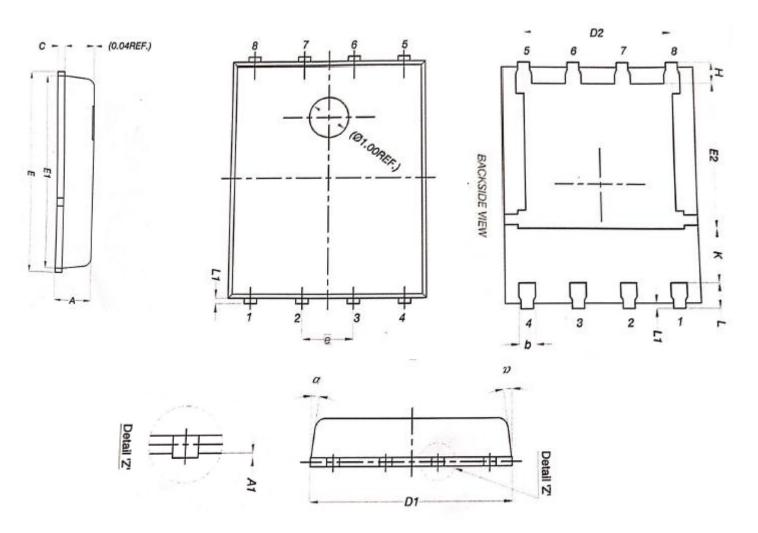


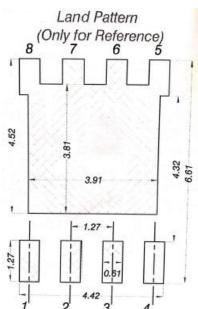
Figure C: Unclamped Inductive Switching Test Circuit and Waveform



DFN5×6 PACKAGR OUTLINE



	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0	ı	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
E	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е	1.27 BSC			
Н	0.41	0.51	0.61	
K	1.10	-	-	
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
a	O°		12°	





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